



PROJECT: B785A REV1  
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IMMERSION GOLD PLATING  
GREEN LPI SOLDERMASK (TOP AND BOTTOM)  
12 LAYERS  
START WITH 1/2 oz. Cu. THROUGHOUT  
5 mil TRACE/ 5 mil SPACE  
QTY: 2 BOARDS  
TURN TIME: 10 WORKING DAYS  
.012" HOLES CAN BE +/- .008"  
BOARD THICKNESS: .093" +/- 10%  
EDGE MILLING: MILL BOARD FROM .093" TO .062" ON TOP AND BOTTOM EDGES  
TEXT "MILL THIS TEXT AWAY" SHOULD BE REMOVED

